



MMBTA05 / MMBTA06

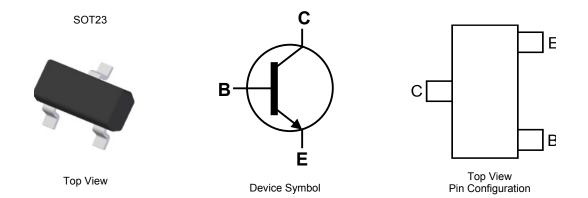
NPN SMALL SIGNAL TRANSISTOR IN SOT23

Features

- Epitaxial Planar Die Construction
- Ideal for Low Power Amplification and Switching
- Complementary PNP Type: MMBTA55 & MMBTA56
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP capable (Note 4)

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (@)
- Weight: 0.008 grams (approximate)



Ordering Information (Notes 4 & 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
MMBTA05-7-F	AEC-Q101	K1G / K1H	7	8	3,000
MMBTA05Q-13-F	Automotive	K1G / K1H	13	8	10,000
MMBTA06-7-F	AEC-Q101	K1G	7	8	3,000
MMBTA06Q-7-F	Automotive	K1G	7	8	3,000

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

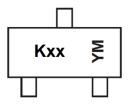
 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Kxx = Product Type Marking Code (See Ordering Information) YM = Date Code Marking

Y or \overline{Y} = Year (ex: A = 2013) M or \overline{M} = Month (ex: 9 = September)

M or M = M on M (ex: 9 = September)

Date	Code	Key
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Notes:

Year	2010	20	011	2012	2	2013	2014		2015	2016		2017
Code	Х		Y	Z		А	В		С	D		E
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	MMBTA05	MMBTA06	Unit
Collector-Base Voltage	V _{CBO}	60	80	V
Collector-Emitter Voltage	V _{CEO}	60	80	V
Emitter-Base Voltage	V _{EBO}	4	.0	V
Collector Current	Ιc	50	00	mA
Peak Collector Current	I _{CM}	1		А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Power Dissipation	(Note 6)	Р	310	mW
	(Note 7)	PD	350	11177
Thermal Desistance, Junction to Ambient	(Note 6)	D	403	0000
Thermal Resistance, Junction to Ambient	(Note 7)	$R_{ extsf{ heta}JA}$	357	°C/W
Thermal Resistance, Junction to Leads (Note 8)		R _{θJL}	350	°C/W
Operating and Storage Temperature Range	T _J ,T _{STG}	-55 to +150	°C	

ESD Ratings (Note 9)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

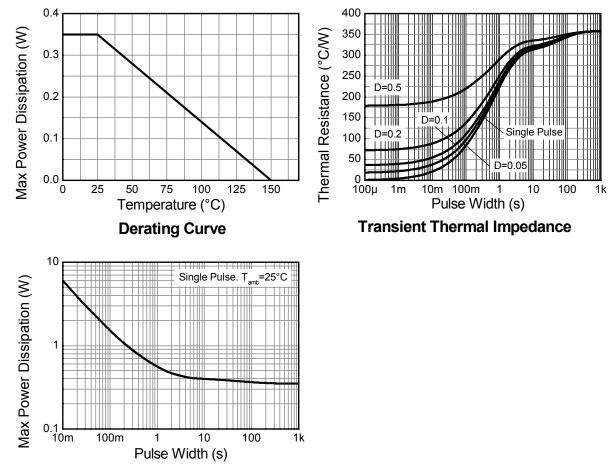
Notes: 6. For a device mounted on minimum recommended pad layout 1oz copper that is on a single-sided FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.

7. Same as note (6), except the device is mounted on 15 mm x 15mm 1oz copper.

Thermal resistance from junction to solder-point (at the end of the leads).
 Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information



Pulse Power Dissipation



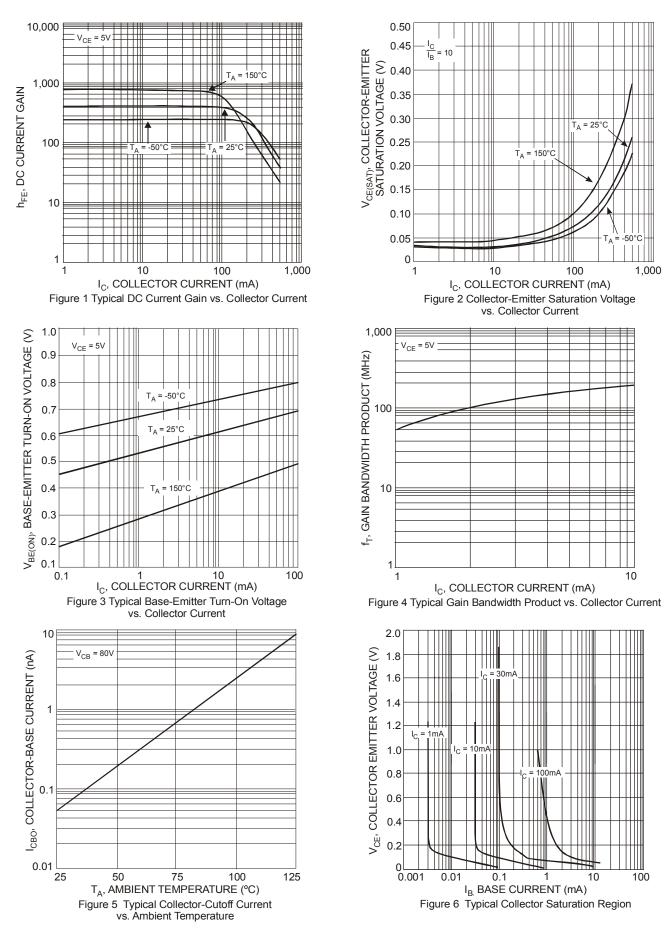
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS						·
Collector-Base Breakdown Voltage	MMBTA05 MMBTA06	BV _{CBO}	60 80	_	V	I _C = 100μA, I _E = 0
Collector-Emitter Breakdown Voltage (Note 10) MMBTA05 MMBTA06		BV _{CEO}	60 80		V	I _C = 10.0mA, I _B = 0
Emitter-Base Breakdown Voltage		BV _{EBO}	4.0		V	I _E = 100 μA, I _C = 0
Collector Cutoff Current	MMBTA05 MMBTA06	I _{CBO}	_	100	nA	$V_{CB} = 60V, I_E = 0$ $V_{CB} = 80V, I_E = 0$
Collector Cutoff Current	MMBTA05 MMBTA06	I _{CES}	_	100	nA	V _{CE} = 60V, I _{BO} = 0V V _{CE} = 80V, I _{BO} = 0V
ON CHARACTERISTICS (Note 10)		•				·
DC Current Gain		h _{FE}	100	_	—	I_{C} = 10mA, V_{CE} = 1.0V I_{C} = 100mA, V_{CE} = 1.0V
Collector-Emitter Saturation Voltage		V _{CE(sat)}	_	0.25	V	I _C = 100mA, I _B = 10mA
Base-Emitter Saturation Voltage	V _{BE(sat)}		1.2	V	I _C = 100mA, V _{CE} = 1.0V	
SMALL SIGNAL CHARACTERISTICS						
Current Gain-Bandwidth Product		f _T	100		MHz	V_{CE} = 2.0V, I_{C} = 10mA, f = 100MHz

Note: 10. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.

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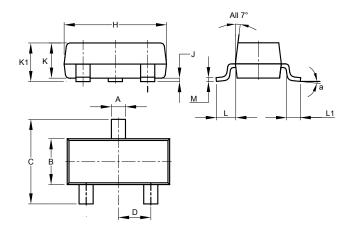


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Package Outline Dimensions

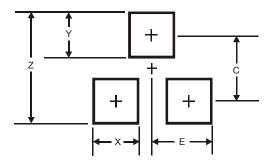
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SOT23									
Dim	Min	Min Max								
Α	0.37	0.51	0.40							
В	1.20	1.40	1.30							
С	2.30	2.50	2.40							
D	0.89	1.03	0.915							
F	0.45	0.60	0.535							
G	1.78	2.05	1.83							
Н	2.80	3.00	2.90							
J	0.013	0.10	0.05							
ĸ	0.890	1.00	0.975							
K1	0.903	1.10	1.025							
L	0.45	0.61	0.55							
L1	0.25	0.55	0.40							
М	0.085	0.150	0.110							
а		8°								
All	Dimens	ions in	mm							

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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